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**APPLICATION DATA SHEET**

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**Inventor Information:**

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**Representative Information:**

<b>Representative Customer Number:</b>	26530
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**Application Information:**

<b>Title:</b>	MULTI-CHIP PACKAGE AND METHOD FOR MANUFACTURING THE SAME
<b>Total Drawing Sheets:</b>	14
<b>Docket:</b>	CU-3609 RJS
<b>Application Type:</b>	Utility

**Continuity Information:**

<b>This application is a:</b>	Division of U.S. Serial No. 10/338,202 filed January 8, 2003
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**Prior Foreign Applications:**

<b>Application:</b>	2002-22113
<b>Filing Date:</b>	April 23, 2002
<b>Country:</b>	Republic of Korea
<b>Priority Claimed:</b>	YES